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Page 5, before line 26, insert the heading:

--Brief Description of the Drawing--;

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Page 6, before line 6, insert the heading:

--Detailed Description--.

**IN THE CLAIMS:**

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1. (Amended) A method of manufacturing a contactless smart card including an integrated-circuit chip [(3)] and an antenna [(2)], in which metallised protrusions [(5)] are produced on two contact pads [(4)] on the chip [(3)], characterised in that the connection of], said method including the step of connecting the chip [(3)] to the antenna [(2)] is effected] by embedding the metallised protrusions [(5)] in the thickness of the antenna [(2)], at the time that the chip [(3)] is attached to the [said] antenna [(2)].

2. (Amended) A method according to Claim 1, [characterised in that] wherein the antenna [(2)] is produced from a material [able to have] that has a viscous state at the time that the chip [(3)] is attached, to allow the embedding of the metallised protrusions [(5)].

3. (Amended) A method according to [one of Claims 1 to 2, characterised in that] claim 1, wherein the antenna [(2)] is produced on an insulating substrate [(1)] to the format of the] having the form factor of a smart card.

4. (Amended) A method according to [one of Claims 1 to 3, characterised in that] claim 1, wherein the antenna [(2)] is produced from a thermoplastic material loaded with metallic particles and [in that] the chip [(3)] is attached to the antenna by thermocompression.

5. (Amended) A method according to [one of Claims 1 to 3, characterised in that] claim 1, wherein the antenna [(2)] is produced from a non-polymerised conductive material and [then] the chip [(3)] is attached to the antenna [(2)] by compression, and [in that an addition of heat polymerises] further including the step of applying heat to polymerize the antenna material.

6. (Amended) A method according to [one of Claims 1 to 3, characterised in that] claim 1, wherein the antenna is produced from a moist conductive polymer material, and [in that] the chip [(3)] is attached to the antenna [(2)] by compression.

7. (Amended) A method according to [one of Claims 1 to 3, characterised in that] claim 1, wherein the antenna [(2)] is produced from a thermoplastic material loaded with metallic particles and the chip [(3)] is [previously] glued to an insulating sheet [(7) to the format of the] having the form factor of a smart card, and [in that] wherein the connection of the chip [(3)] to the antenna [(2)] is effected by hot lamination.